

WL Series Liquid Cooling System

The LA5000 is a recirculating liquid to air heat exchanger that offers dependable, compact performance by removing large amounts of heat from a liquid circuit. The coolant is re-circulated using a high-pressure pump to assure maximum flow rate. Heat from coolant is absorbed by a radiant heat exchanger and dissipated into the ambient environment using brand name fan. Manual adjustments can be made to control flow switch. Customized features are available, however, MOQ applies.

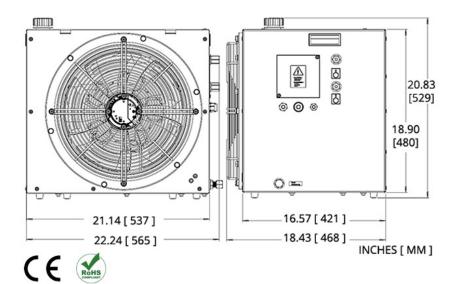


Features

- Cooling to ambient
- High heat pumping capacity
- Compact form factor
- Long life operation

Applications

- Cooling Particle Accelerators: Linear Accelerators and Cyclotrons
- Semiconductor Fabrication Equipment Cooling
- X-ray Cooling in Industrial Scanners



FLUID OPERATING POINTS

100% Water

Cooling Power (Qc) = 5000 Watts Thermal Conductance = 474.5 W/°C ΔT (Ambient-Coolant)* = 10.5 °C ΔT (Outlet-Inlet)** @ 8.3 L/min = 9.6 °C

60/40 Water-Glycol

Cooling Power (Qc) = 5000 Watts Thermal Conductance = 400.4 W/°C Δ T (Ambient-Coolant)* = 12.5 °C Δ T (Outlet-Inlet)** @ 8.3 L/min = 10.5 °C

70/30 Water-Glycol

Cooling Power (Qc) = 5000 Watts Thermal Conductance = 441.5 W/°C Δ T (Ambient-Coolant)* = 11.3 °C Δ T (Outlet-Inlet)** @ 8.3 L/min = 10.1 °C

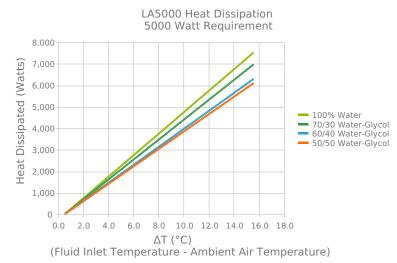
50/50 Water-Glycol

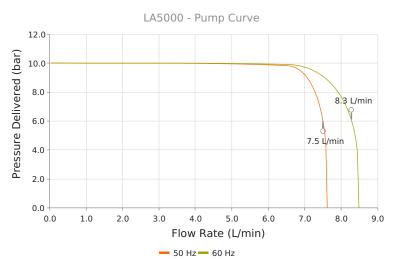
Cooling Power (Qc) = 5000 Watts Thermal Conductance = 388.4 W/°C Δ T (Ambient-Coolant)* = 12.9°C Δ T (Outlet-Inlet)** @ 8.3 L/min = 11.1 °C

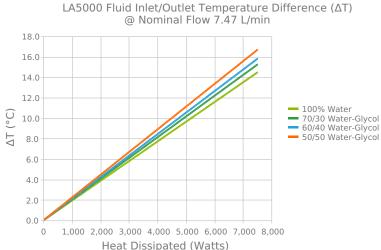
^{*} ΔT (Ambient-Coolant) is the temperature difference between the ambient temperature and the coolant temperature that is at the outlet of the heat exchanger during steady-state operation. This temperature difference would initially be 0 and increase to the steady state value under load. This would also be the temperature at the inlet to the application.

^{**} ΔT (Outlet-Inlet) is the temperature difference between the inlet temperature and the outlet temperature of the application at the nominal coolant flow. More flow (application pressure drop less than nominal) would necessarily mean a smaller ΔT .











TECHNICAL SPECIFICATIONS

Performance

Nominal Cooling Capacity	5,000 W
Nominal Operating Flowrate (60 Hz)	8.3 L/min @ 6.0 Bar
Nominal Operating Flowrate (50 Hz)	7.5 L/min @ 6.0 Bar

Operation

Coolant	Water or Water/Glycol
Operating Temperature	5°C to 40°C
Storage temperature range (w/o coolant)	-25°C to 70°C
Humidity range	20% to 80%
Storage Humidity range	5% to 95%, non-condensing
Input Voltage	200 - 240 VAC
Frequency	50/60 Hz
Current	< 3.3 Amps
Flow Switch Open	≤ 4 L/min
Maximum Forward Pressure	10 Bar
Compliance	ANSI / UL / CSA / IEC EN 61010-1 Edition 3

Physical

Height	529 mm
Length	565 mm
Width	468 mm
Weight	40 kg
Coolant Capacity	6.2 Liters
Couplings	G 3/8 in



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High heat pumping capacity	Semiconductor Fabrication Equipment Cooling
Compact form factor	X-ray Cooling in Industrial Scanners
Long life operation	

NOTES

- 1. Check coolant level regularly. For optimal cooling performance, coolant level should always be above radiator fins.
- 2. Hose selection should be of material and thickness to support pressure resistance and coolant type.
- 3. Manual adjustments can be made to control pressure and flow rate.
- 4. Check pump filter and dust on heat exchanger periodically for cleaning.

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